

App. No. 10/607,613  
Amend. Dated 8/29/05  
Response To Action dated 6/10/05



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the application of	)	
Kiermasz et al.	)	Examiner: Rachuba, Maurina T.
Application No: 10/607,613	)	Art Unit: 3723
Filed: June 27, 2003	)	Atty. Docket No: LAM2P421
For: PLATEN WITH DIAPHRAGM AND	)	Date: August 29, 2005
METHOD FOR OPTIMIZING WAFER)	)	
POLISHING	)	
_____	)	

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on August 29, 2005.

Signed \_\_\_\_\_

*Kay Harlow*  
Kay Harlow

**SUBMISSION UNDER 37 CFR 1.114**

Mail Stop RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Honorable Commissioner:

In response to the Final Office Action mailed June 10, 2005, which set a three month shortened period for response, please consider this as a Submission under 37 CFR 1.114, amend the captioned application as follows, and consider the following remarks.

**Amendments to the claims** start on page 2.

**Remarks** start on page 13.